



NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



THIS PAGE INTENTIONALLY LEFT BLANK



MICROWAVE CORPORATION v03.0414



HMC144LC4

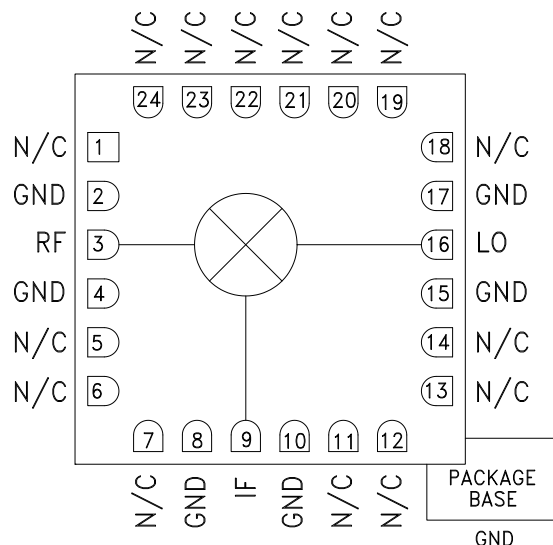
GaAs MMIC DOUBLE-BALANCED MIXER, 6 - 20 GHz

Typical Applications

The HMC144LC4 is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

Functional Diagram



Features

- +23 dBm Input IP3
- 35 dB LO/Rf Isolation
- IF Bandwidth: DC to 3 GHz
- RoHS Compliant 4x4 mm SMT Package

General Description

The HMC144LC4 is a Double-Balanced MMIC Mixer in a leadless "Pb free" SMT package which can be used as an upconverter or downconverter from 6 to 20 GHz. Broadband operation and 30 to 40 dB isolations are provided by on-chip baluns, which require no external components or DC bias. MMIC mixers are more reliable replacements to hybrid diode mixers assuring consistent conversion loss and isolation performance over high volume production lots. The HMC144LC4 eliminates the need for wire bonding, allowing use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^\circ\text{C}$

Parameter	IF = 100 MHz LO = +20 dBm						Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF & LO	6 - 12			12 - 20			GHz
Frequency Range, IF	DC - 3			DC - 3			GHz
Conversion Loss		9.5	11.5		11	13	dB
Noise Figure (SSB)		9.5	11.5		11	13	dB
LO to RF Isolation	25	35		25	35		dB
LO to IF Isolation	15	20		15	20		dB
RF to IF Isolation	15	25		15	25		dB
IP3 (Input)		23			23		dBm
1 dB Compression (Input)	12	15		12	15		dBm

* Unless otherwise noted, all measurements performed as downconverter, IF= 100 MHz.

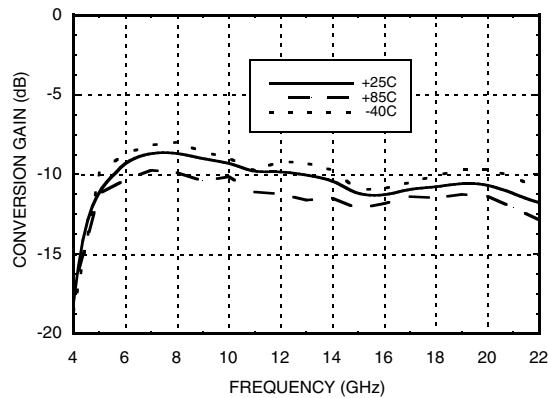
For price, delivery and to place orders: Hittite Microwave Corporation, 2 Elizabeth Drive, Chelmsford, MA 01824

Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

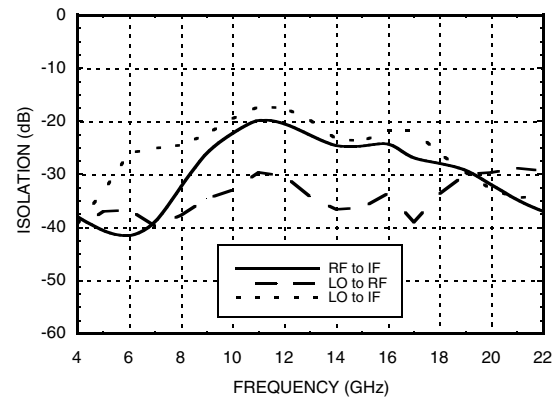
Application Support: Phone: 978-250-3343 or apps@hittite.com

GaAs MMIC DOUBLE-BALANCED MIXER, 6 - 20 GHz

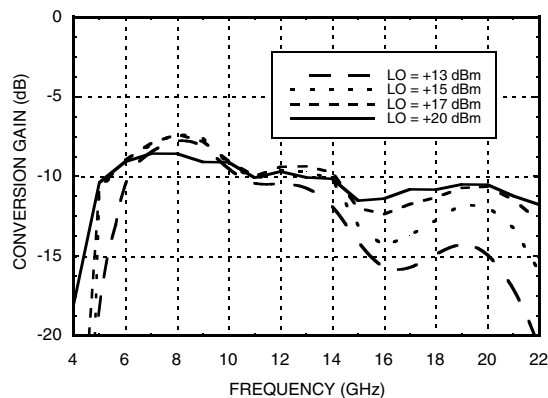
Conversion Gain vs. Temperature @ LO = +20 dBm



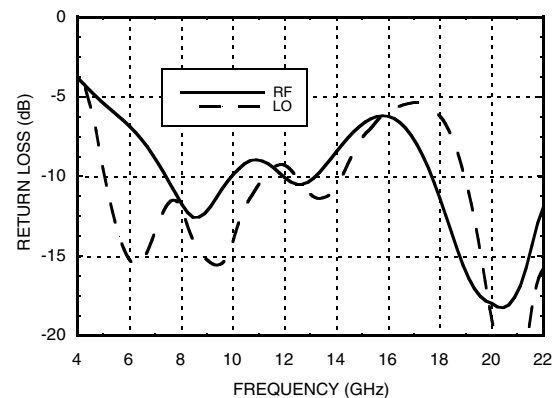
Isolation @ LO = +20 dBm



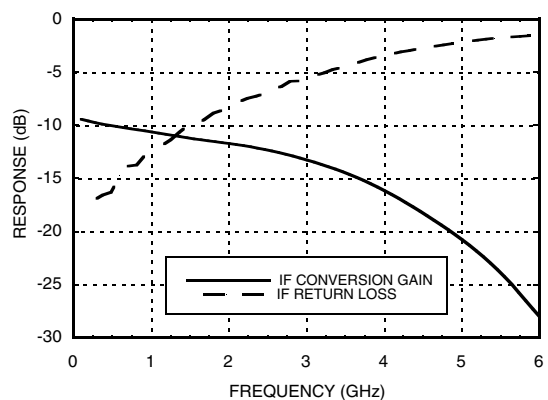
Conversion Gain vs. LO Drive



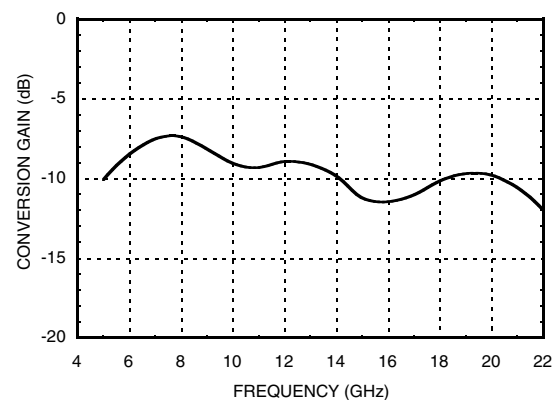
Return Loss @ LO = +20 dBm



IF Bandwidth @ LO = +20 dBm



**Upconverter Performance
Conversion Gain @ LO = +20 dBm**





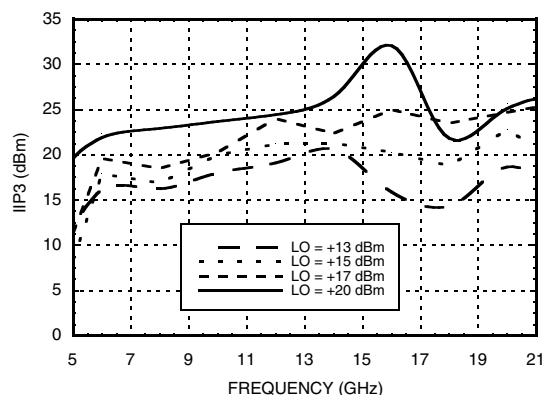
MICROWAVE CORPORATION v03.0414



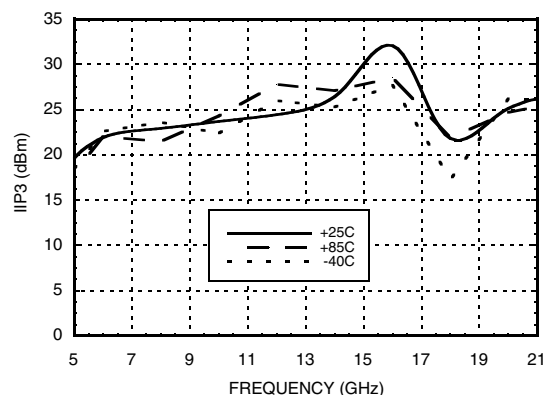
HMC144LC4

GaAs MMIC DOUBLE-BALANCED MIXER, 6 - 20 GHz

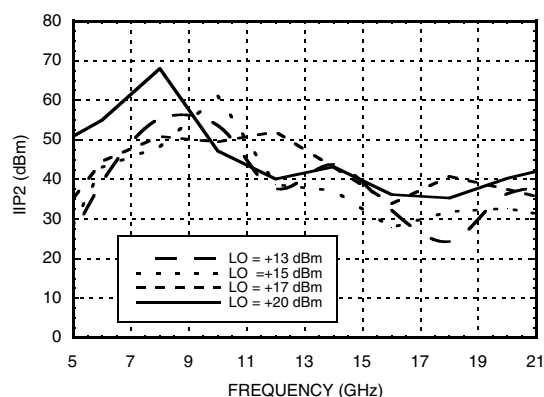
Input IP3 vs. LO Drive*



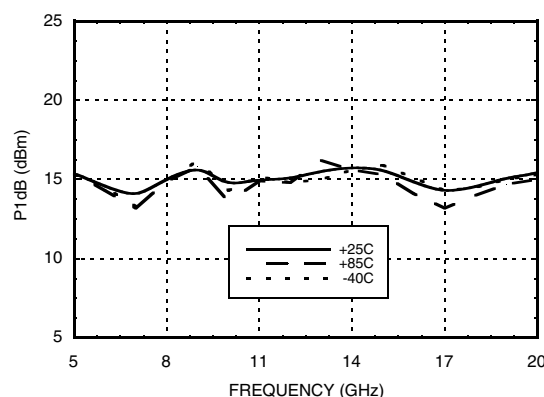
Input IP3 vs. Temperature @ LO = +20 dBm*



Input IP2 vs. LO Drive *



Input P1dB vs. Temperature @ LO = +20 dBm



MxN Spurious @ IF Port

mRF	nLO				
	0	1	2	3	4
0	XX	0	5	37	N/A
1	7	0	49	42	54
2	47	66	44	56	57
3	>95	>95	>95	58	77
4	N/A	>95	>95	>95	>95

RF = 12 GHz @ -10 dBm
LO = 12.1 GHz @ 20 dBm
All values in dBc relative to the IF power level.
Measured as downconverter.

Harmonics of LO

LO Freq. (GHz)	nLO Spur @ RF Port			
	1	2	3	4
9	25	18	46	53
10.5	25	20	52	66
12	27	24	47	63
13.5	27	33	61	N/A
15	27	47	67	N/A
16.5	24	52	63	N/A

LO = +20 dBm
All values in dBc below input LO level @ RF port.

* Two-tone input power = 0 dBm each tone, 1 MHz spacing.



MICROWAVE CORPORATION v03.0414



HMC144LC4

GaAs MMIC DOUBLE-BALANCED MIXER, 6 - 20 GHz

Absolute Maximum Ratings

RF / IF Input	+15 dBm
LO Drive	+27 dBm
IF DC Current	±2 mA
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS



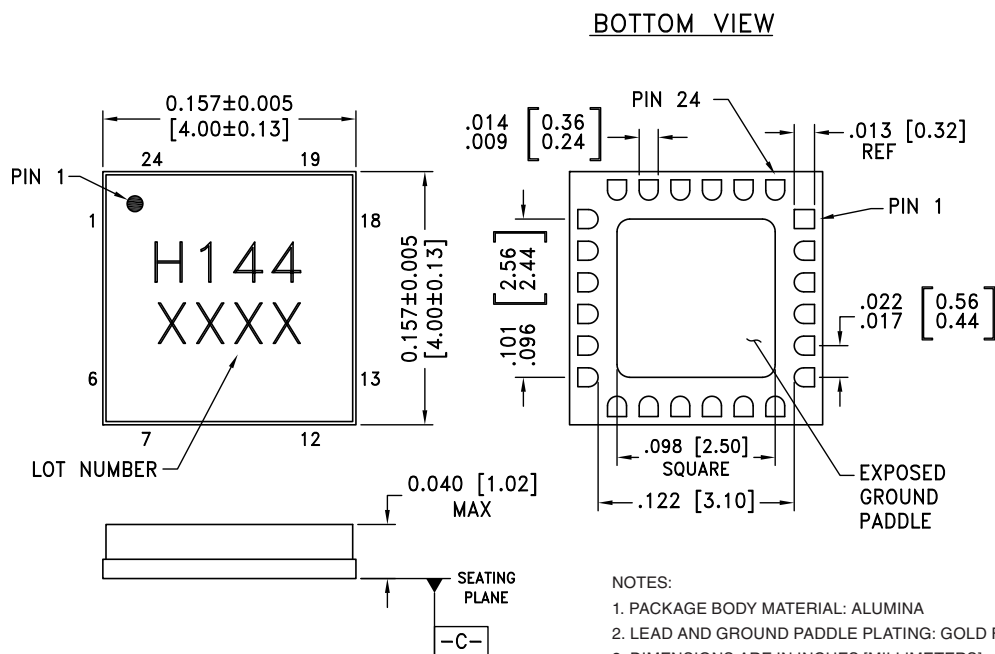
MICROWAVE CORPORATION v03.0414



HMC144LC4

**GaAs MMIC DOUBLE-BALANCED
MIXER, 6 - 20 GHz**

Outline Drawing



NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER Ni.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

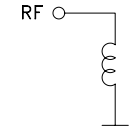
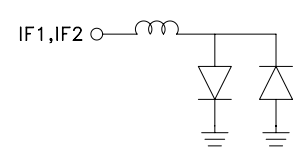
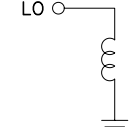
Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC144LC4	Alumina, White	Gold over Nickel	MSL3 ^[1]	H144 XXXX

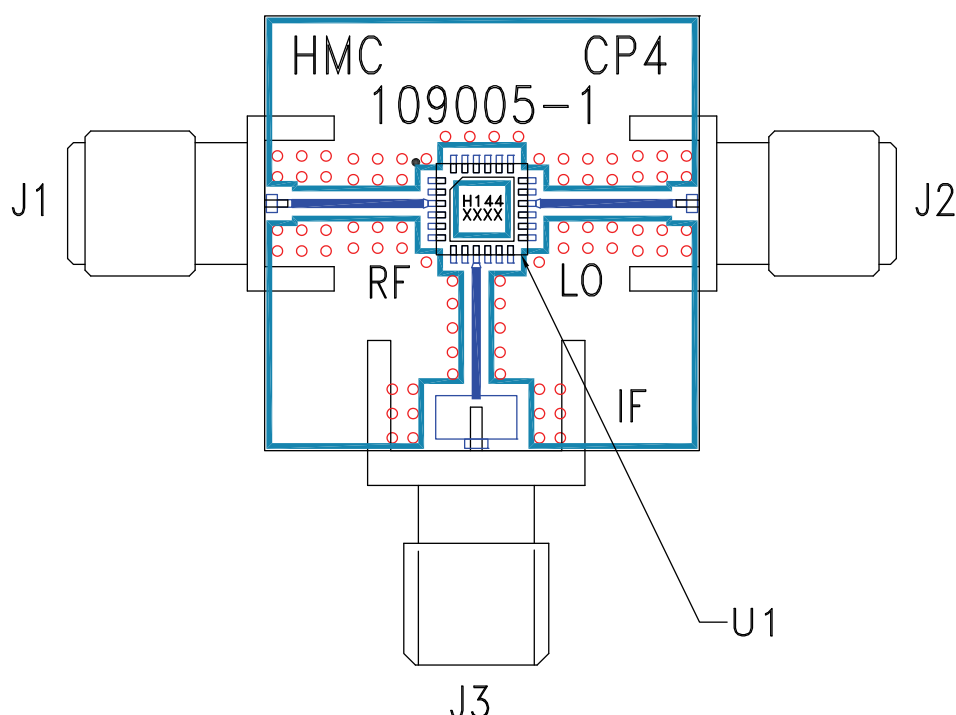
[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 5 - 7, 11 - 14, 18 - 24	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
2, 4, 8, 10, 15, 17	GND	These pins and package bottom must be connect to RF/DC ground.	
3	RF	This pin is AC coupled and matched to 50 Ohms from 6 - 20 GHz	
9	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 2 mA of current or die non-function and possible die failure will result.	
16	LO	This pin is AC coupled and matched to 50 Ohms from 6 - 20 GHz	

Evaluation PCB



List of Materials for Evaluation PCB 109010 ^[1]

Item	Description
J1 - J2	PCB Mount SMA RF Connector, SRI
J3	PCB Mount SMA Connector, Johnson
U1	HMC144LC4
PCB [2]	109005 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



MICROWAVE CORPORATION

v03.0414



HMC144LC4

***GaAs MMIC DOUBLE-BALANCED
MIXER, 6 - 20 GHz***

MIXERS - SINGLE & DOUBLE BALANCED - SMT



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.